

Part number	Inductance (uH) ±20%	DC Resistance (mΩ) Typical	DC Resistance (mΩ) MAX.	Rated Current (A) Typical	I sat (A) Typical
MCS0420-R10MN2	0.10	3.5	4.0	12.0	22.0
MCS0420-R12MN2	0.12	4.5	5.0	12.0	12.0
MCS0420-R15MN2	0.15	6.0	6.6	9.0	13.0
MCS0420-R22MN2	0.22	6.0	6.6	9.0	12.5
MCS0420-R33MN2	0.33	9.6	11.0	10.0	13.0
MCS0420-R47MN2	0.47	12.5	14.0	7.0	9.5
MCS0420-R56MN2	0.56	14.0	16.0	6.5	10.0
MCS0420-R68MN2	0.68	16.0	18.0	6.0	9.0
MCS0420-1R0MN2	1.0	24.0	27.0	4.5	7.0
MCS0420-1R2MN2	1.2	24.0	27.0	4.5	7.0
MCS0420-1R5MN2	1.5	38.0	46.0	4.0	6.0
MCS0420-2R2MN2	2.2	52.0	58.0	3.0	5.0
MCS0420-3R3MN2	3.3	74.0	87.0	2.5	4.0
MCS0420-4R7MN2	4.7	98.0	110.0	2.2	3.5
MCS0420-5R6MN2	5.6	105.0	115.0	1.8	3.5
MCS0420-6R8MN2	6.8	160.0	175.0	1.5	2.5
MCS0420-100MN1	10.0	256.0	282.0	1.2	2.2

TEST INSTRUMENT: <u>CHROMA 16502 Zentech1320+Zentech3305</u> NOTE:

1. Test Freq.: 100KHz, 1.0V

2. All test data is referenced to 25°C ambient.

3. Operating Temperature Range -25°C ~+125°C.

4. Storage Temperature Range: -20°C~+40°C (<60% R.H.).

5. Rated Current: DC current(A)that will cause an approximate ΔT of 40°C.

6. I sat: DC current (A) that will cause Lo to drop approximately 30%.

7. The part temperature(ambient +temp rise)should not exceed 125°C under worst case operating conditions.

8. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature Part temperature should be verified.

9. MSL: Level 1



